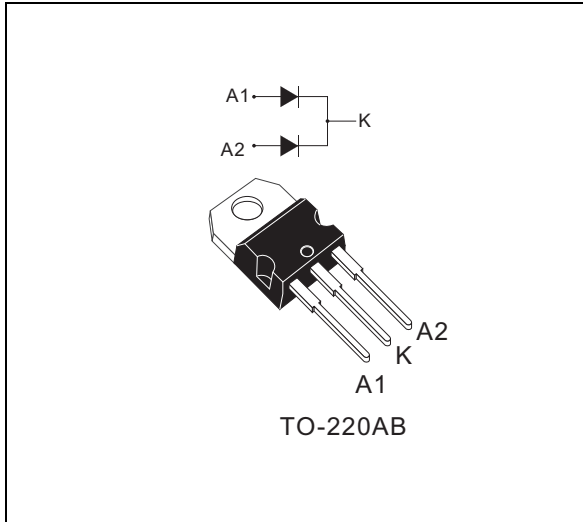


## Automotive turbo 2 ultrafast high voltage rectifier

Datasheet - production data



### Description

The STTH16L06C-Y is developed using ST's Turbo 2 600 V technology. It's specially suited for use in switching power supplies as rectifier and discontinuous mode PFC boost diode for automotive applications.

Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	Up to 2 x 10 A
$V_{RRM}$	600 V
$T_j$	175 °C
$V_F$ (typ)	1.05 V
$t_{rr}$ (max)	35 ns

### Features

- AEC-Q101 qualified
- Ultrafast switching
- Low reverse recovery current
- Reduces switching and conduction losses
- Low thermal resistance
- PPAP capable
- ECOPACK<sup>®</sup>2 compliant component

# 1 Characteristics

**Table 2. Absolute ratings (limiting values)**

Symbol	Parameter		Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage, $T_j = -40\text{ °C}$		600	V	
$I_{F(RMS)}$	Forward rms current		30	A	
$I_{F(AV)}$	Average forward current $\delta = 0.5$	TO-220AB	$T_c = 140\text{ °C}$ Per diode	8	A
			$T_c = 135\text{ °C}$ Per device	16	
			$T_c = 130\text{ °C}$ Per diode	10	
			$T_c = 120\text{ °C}$ Per device	20	
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ ms}$ sinusoidal	120	A	
$T_{stg}$	Storage temperature range		-65 to + 175	°C	
$T_j$	Operating junction temperature		-40 to +175	°C	

**Table 3. Thermal parameter**

Symbol	Parameter		Maximum	Unit	
$R_{th(j-c)}$	Junction to case	TO-220AB	Per diode	2.5	°C/W
		TO-220AB	Total	1.6	
$R_{th(c)}$	Coupling	TO-220AB		0.7	

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j (\text{diode1}) = P_{(\text{diode1})} \times R_{th(j-c)} (\text{per diode}) + P_{(\text{diode2})} \times R_{th(c)}$$

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$			8	$\mu\text{A}$
		$T_j = 150\text{ °C}$			25	240	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 8\text{A}$			1.8	V
		$T_j = 150\text{ °C}$			1.05	1.35	
		$T_j = 25\text{ °C}$	$I_F = 16\text{A}$			2.08	
		$T_j = 150\text{ °C}$			1.28	1.64	

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$
2. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation:

$$P = 1.06 \times I_{F(AV)} + 0.036 I_{F(RMS)}^2$$

Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25\text{ °C}$	$I_F = 0.5\text{ A}$ , $I_{rr} = 0.25\text{ A}$ , $I_R = 1\text{ A}$			35	ns
			$I_F = 1\text{ A}$ , $di_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$		40	55	
$I_{RM}$	Reverse recovery current	$T_j = 125\text{ °C}$	$I_F = 8\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 400\text{ V}$		4.5	6.5	A
$t_{fr}$	Forward recovery time	$T_j = 25\text{ °C}$	$I_F = 8\text{ A}$ $di_F/dt = 100\text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}$			200	ns
$V_{FP}$	Forward recovery voltage				3.5		V

Figure 1. Conduction losses versus average current

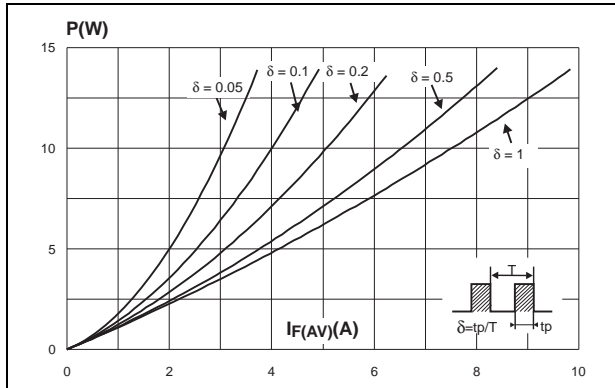


Figure 2. Forward voltage drop versus forward current

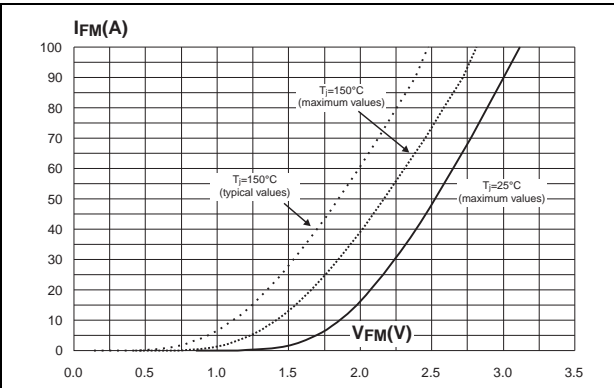


Figure 3. Peak reverse recovery current versus  $di_F/dt$  (typical values, per diode)

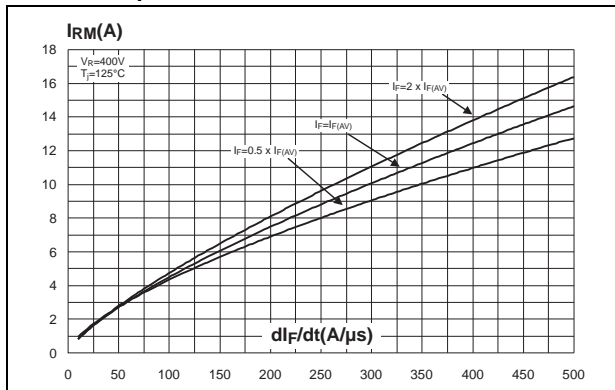


Figure 4. Reverse recovery time versus  $di_F/dt$  (typical values, per diode)

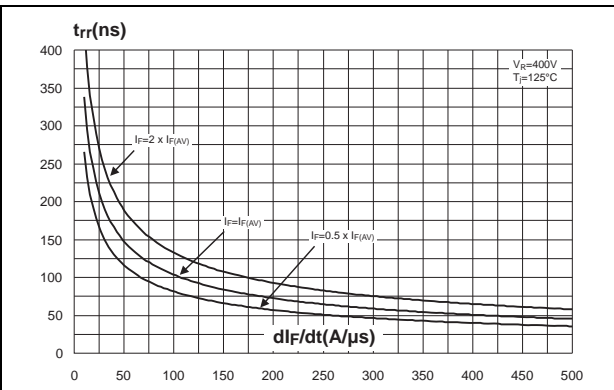


Figure 5. Reverse recovery charges versus  $di_F/dt$  (typical values, per diode)

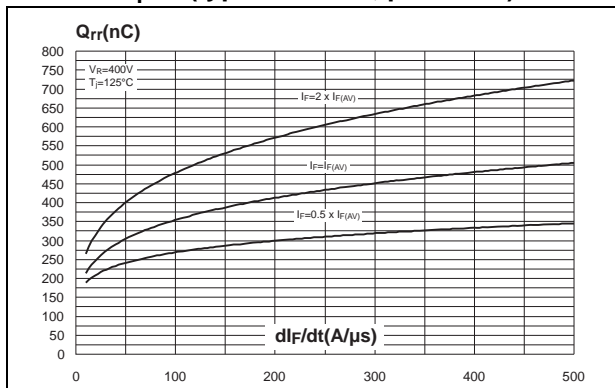


Figure 6. Softness factor versus  $di_F/dt$  (typical values, per diode)

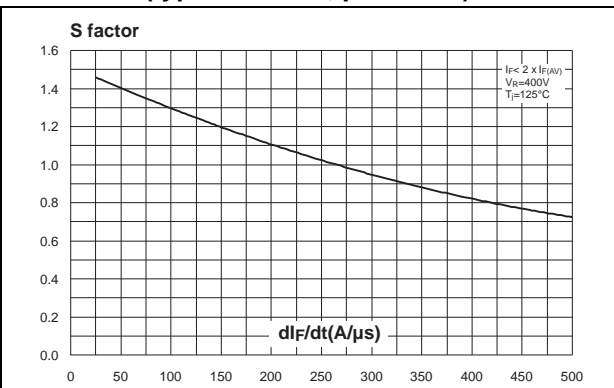


Figure 7. Relative variations of dynamic parameters versus junction temperature

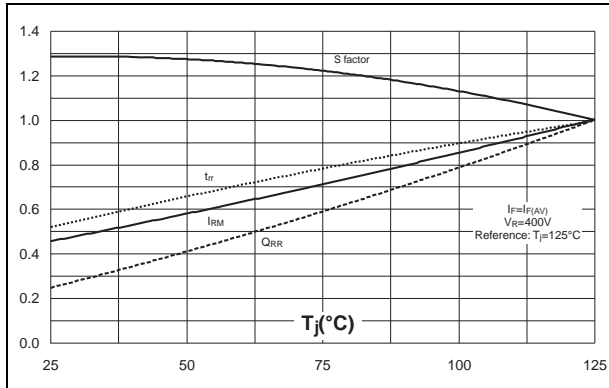


Figure 8. Transient peak forward voltage versus  $di_F/dt$  (typical values, per diode)

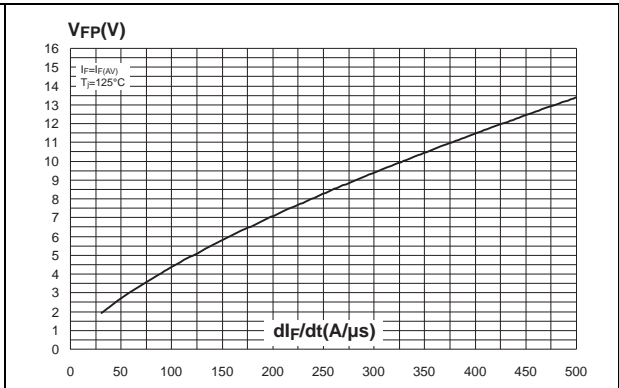


Figure 9. Forward recovery time versus  $di_F/dt$  (typical values, per diode)

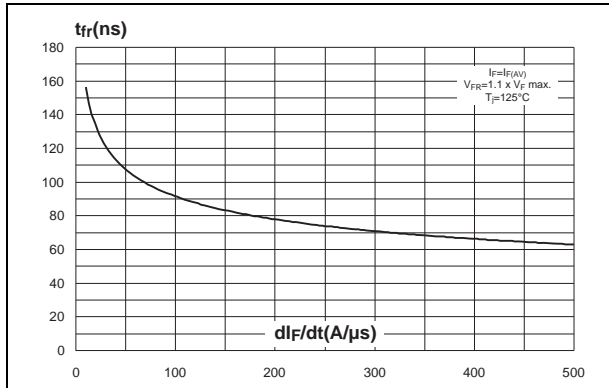
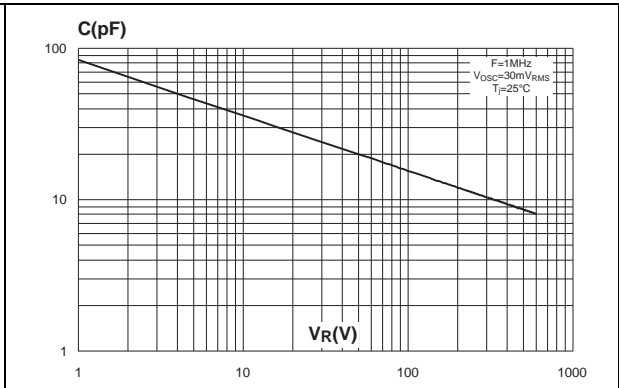


Figure 10. Junction capacitance versus reverse voltage applied (typical values, per diode)



## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value for TO-220AB and TO-220FPAB: 0.4 N·m to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

Figure 11. TO-220AB dimension definitions

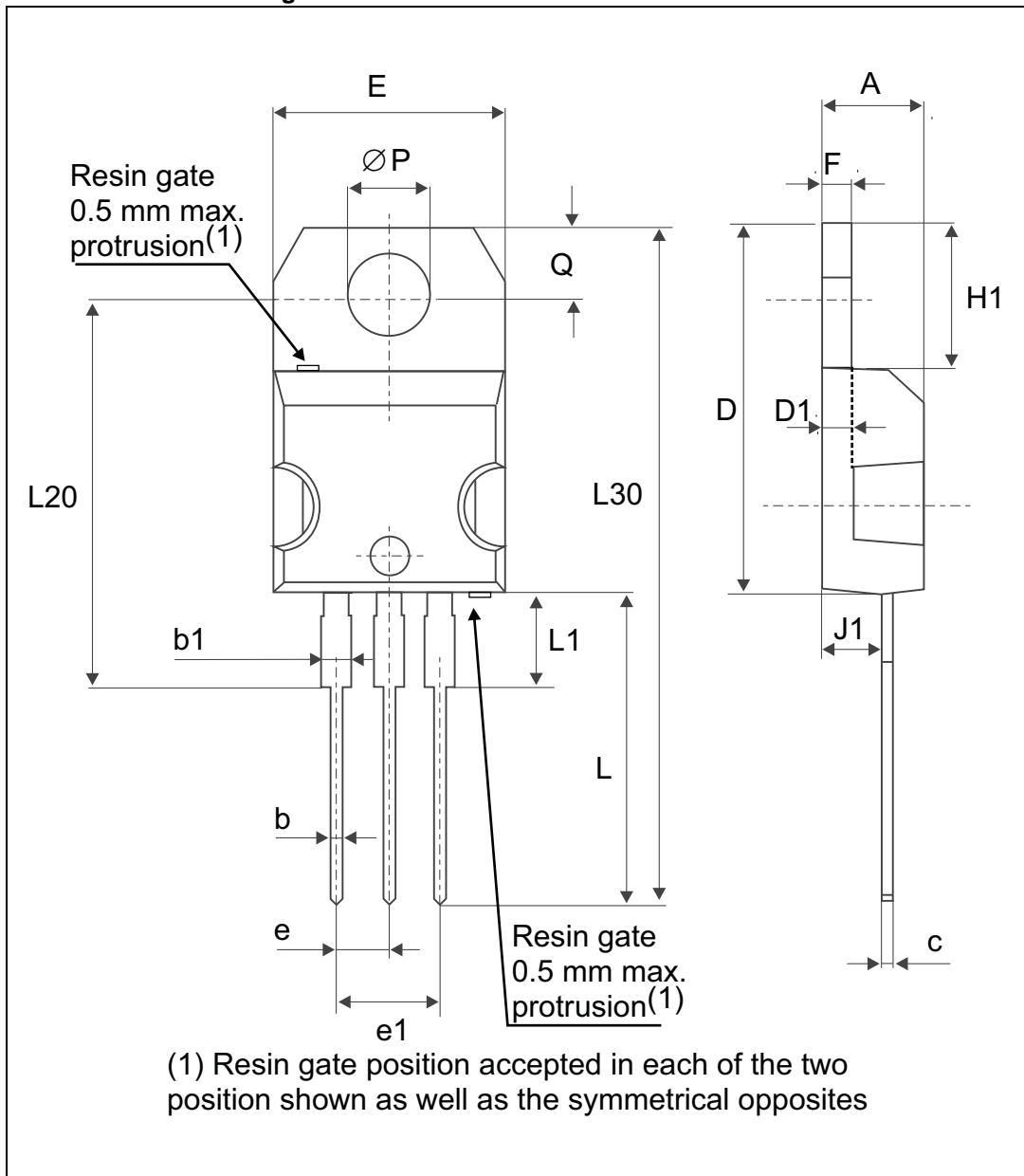


Table 6. TO-220AB dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.17	0.18
b	0.61	0.88	0.024	0.035
b1	1.14	1.70	0.045	0.067
c	0.48	0.70	0.019	0.027
D	15.25	15.75	0.60	0.62
D1	1.27 typ.		0.05 typ.	
E	10	10.40	0.39	0.41
e	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.19	0.20
F	1.23	1.32	0.048	0.052
H1	6.20	6.60	0.24	0.26
J1	2.40	2.72	0.094	0.107
L	13	14	0.51	0.55
L1	3.50	3.93	0.137	0.154
L20	16.40 typ.		0.64 typ.	
L30	28.90 typ.		1.13 typ.	
ØP	3.75	3.85	0.147	0.151
Q	2.65	2.95	0.104	0.116

### 3 Ordering information

**Table 7. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH16L06CTY	STTH16L06CTY	TO-220AB	2.23 g	50	Tube

### 4 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
19-Nov-2014	1	First issue.
12-Dec-2014	2	Removed TO-220FPAB and D <sup>2</sup> PAK package information.



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